

# SPECIFICATION

## 产品规格书

NO.(编号) : RD vision

Part No.(型号) : 5050A06-XXN75-2S5P-HV2-T-LX

Description(描述) : 5050 White LED

Model(说明) : EMC5050 6V CRI70 高色点 合金线

CUSTOMER APPEROVED (客户审核)	APPROVED (核准)	ISSUED (制定)
	朱磊	王磊

SHINEON (NANCHANG) TECHNOLOGY CO.,LTD

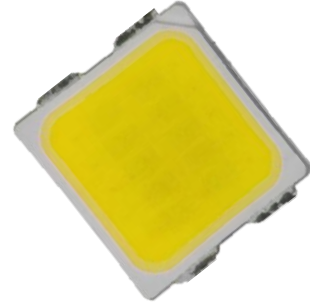
699 Tianxiang Avenue, Building 7-1, CEC Low-Carbon Technology Park, High-Tech  
Development District, Nanchang City, Jiangxi Province, P.R.China  
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## 5050A06-XXN75-2S5P-HV2-T-LX Datasheet

This 5050 LED Light Source is a high performance energy efficient device which can handle high thermal and high driving current. The small package outline and high intensity make it an ideal choice for LED panel light, LED bulb light, LED tube light, backlighting and etc.

The White Power LED is available in the range of color temperature from 2700K to 6500K.

This part has a foot print that is compatible to most of the same size LED in the market today.



### FEATURES

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- Available in Cool White, Neutral White and Warm White color
- High luminous Intensity and high efficiency
- Compatible with reflow soldering process
- Low thermal resistance
- Long operation life
- Wide viewing angle at 120°
- Silicone encapsulation
- Environmental friendly, RoHS compliance

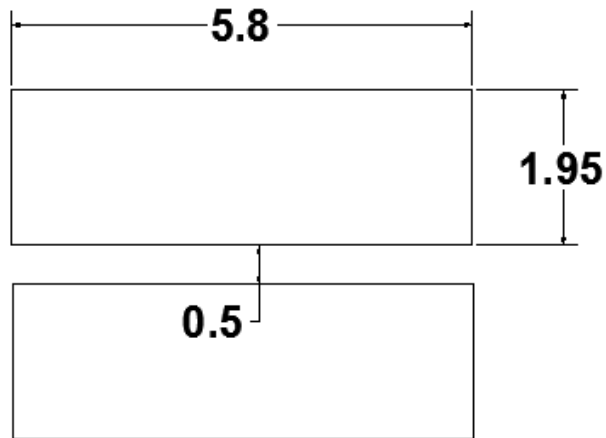
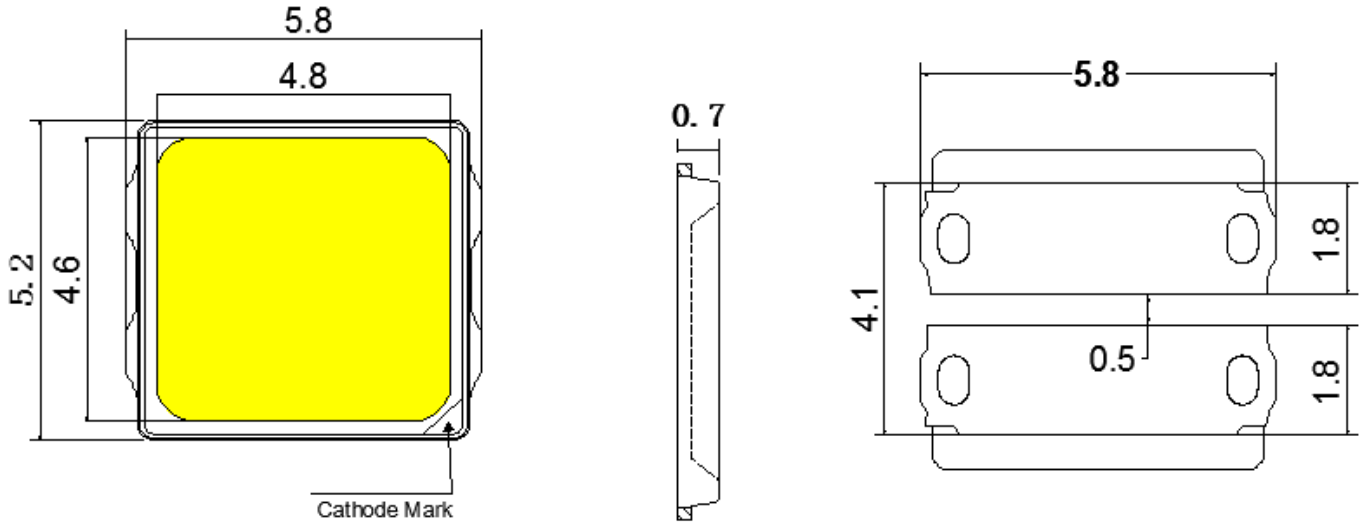
### APPLICATIONS

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- Street lighting
- Par lighting
- Outdoor lighting

Note: The information in this document is subject to change without notice.

**PACKAGE DIMENSIONS**



**Recommended PCB Soldering Pad Pattern**

**Notes:**

1. All dimensions in millimeters.
2. Thickness tolerance of copper plate is  $\pm 0.02$ mm.
3. Thickness tolerance of product is  $\pm 0.05$ mm.
4. Tolerance is  $\pm 0.1$ mm unless otherwise noted.

**ABSOLUTE MAXIMUM RATINGS**

Item	Symbol	Absolute Maximum Rating	Unit
Forward current	$I_F$	1000	mA
Peak Forward Current <sup>[1]</sup>	$I_{FP}$	1500	mA
Reverse Voltage	$V_R$	10	V
Power Dissipation	$P_d$	6700	mW
Operating solder point Temperature	$T_{SP}$	-40~+105	°C
Storage Temperature	$T_{stg}$	-40~+105	°C
Soldering Temperature	$T_{sld}$	Reflow Soldering: 260°C for 10 seconds	
LED Junction Temperature	$T_j$	125	°C
ESD Sensitivity (HBM)	--	2000	V

Note:

$I_{FP}$  Conditions: Pulse Width  $\leq 10$ msec. and Duty  $\leq 1/10$ .

**CHARACTERISTICS (T<sub>j</sub>=25°C)**

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Forward Voltage <sup>[1]</sup>	$V_F$	IF=750mA	5.8	--	6.6	V
Viewing Angle	$2\theta_{1/2}$	IF=750mA	--	120	--	deg.
Luminous Flux	$\Phi_v$	IF=750mA	800	--	930	lm
Color Rendering Index	CRI	IF=750mA	70	--	--	--
Color Temperature	CCT	IF=750mA	2700	--	6500	K
Thermal Resistance (Junction to Solder Point)	$R_{th-js}$	IF=750mA	--	2.8	--	°C/W

Notes:

- Luminous flux is measured with an accuracy of  $\pm 10\%$ .
- Chromaticity coordinate bins are measured with an accuracy of  $\pm 0.01$ .
- CRI is measured with an accuracy of  $\pm 2$  ;
- Some color and CRI bins may have limited availability, please contact us before ordering.
- All measurements were made under the standardized environment of Shineon

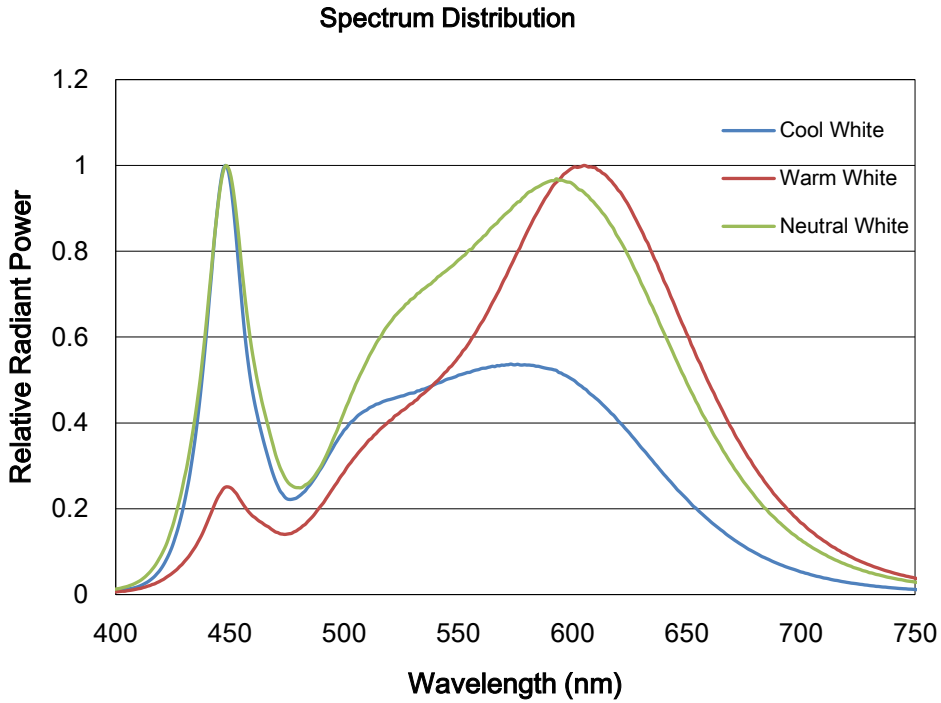
**ELECTRO-OPTICAL CHARACTERISTICS 光电参数**
**(Tj=25°C; CRI70 ; 4000K)**

Forward Current	Forward Voltage	Power	Luminous Flux	Luminous efficacy
IF ( mA )	Typ VF ( V )	Typ P ( W )	Typ ΦV ( lm )	Typ η ( lm/W )
100	5.31	0.5	132	248
200	5.46	1.1	260	238
300	5.58	1.7	382	228
400	5.69	2.3	503	221
500	5.80	2.9	619	214
600	5.90	3.5	731	207
700	5.99	4.2	840	200
750	6.04	4.5	898	198
800	6.09	4.9	951	195
900	6.17	5.6	1056	190
1000	6.26	6.3	1154	184

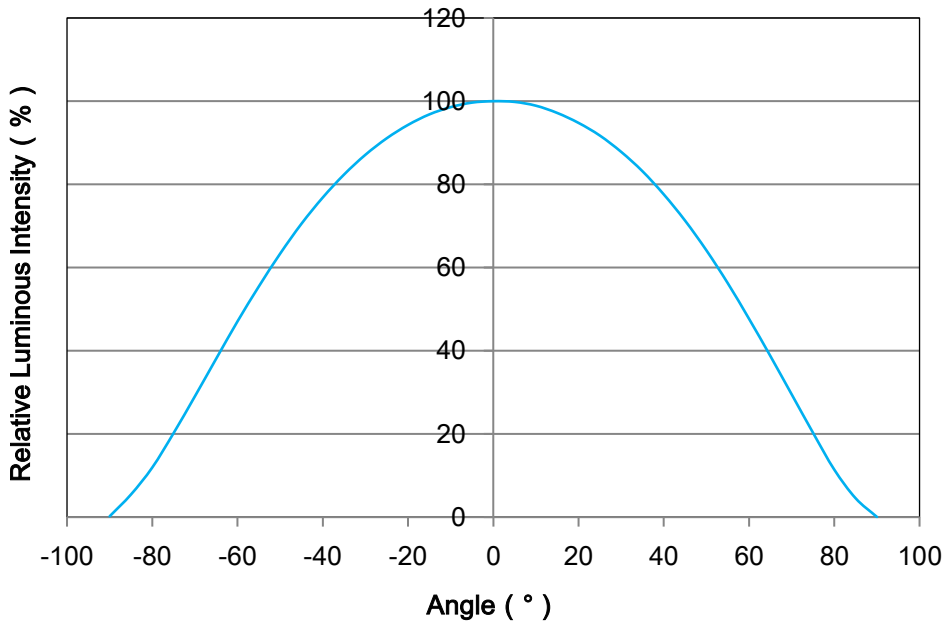
## Notes:

1. Luminous flux is measured with an accuracy of  $\pm 10\%$ .
2. Chromaticity coordinate bins are measured with an accuracy of  $\pm 0.01$ .
3. CRI is measured with an accuracy of  $\pm 2$  ;
4. Some color and CRI bins may have limited availability, please contact us before ordering.
5. All measurements were made under the standardized environment of Shineon

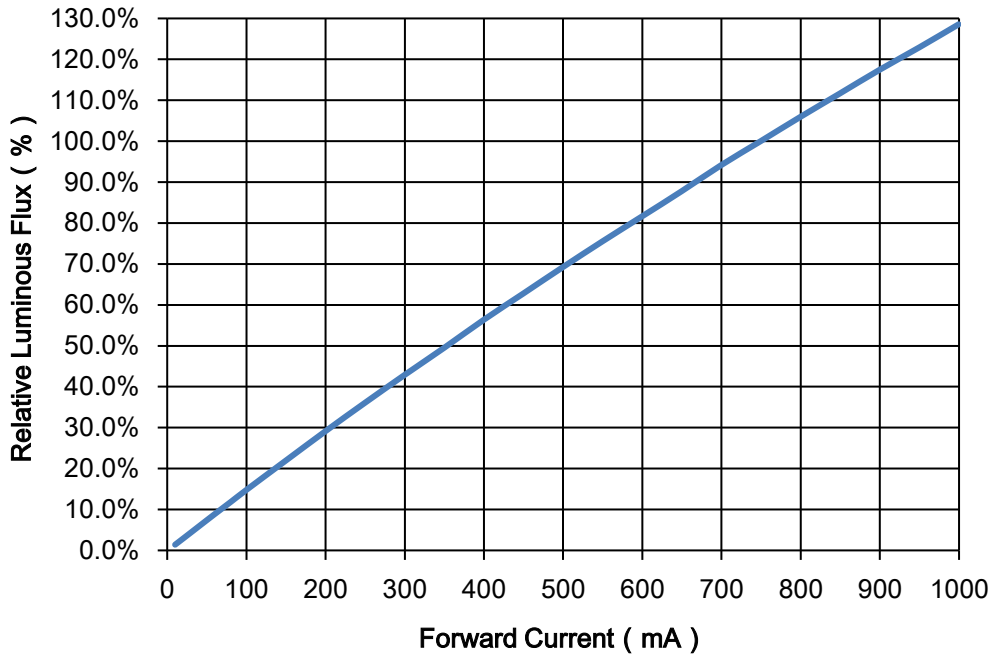
**RELATIVE SPECTRAL POWER DISTRIBUTION (T<sub>j</sub>=25°C)**



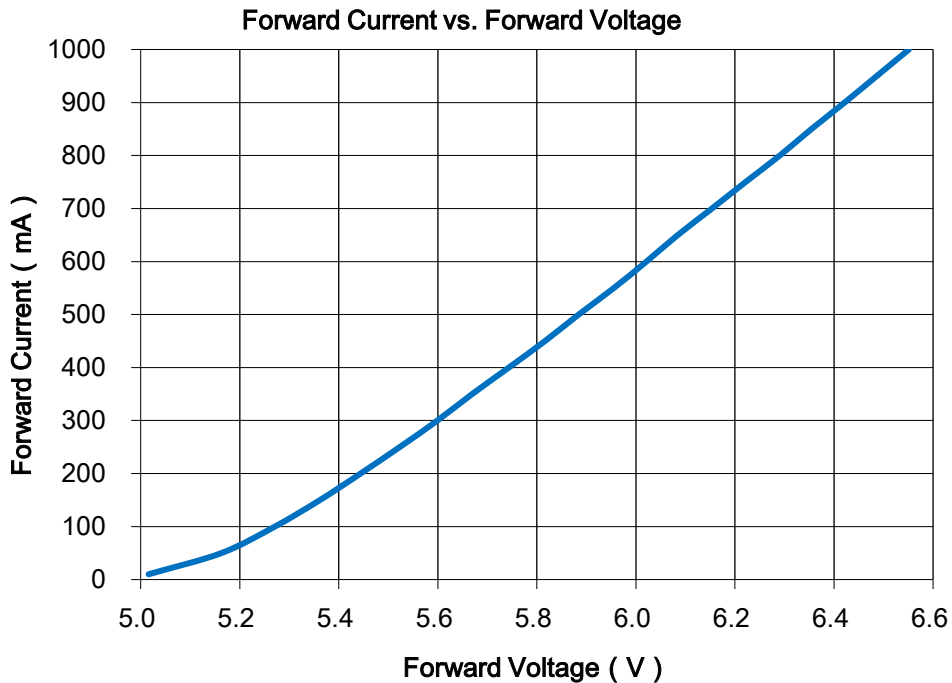
**TYPICAL SPATIAL DISTRIBUTION**



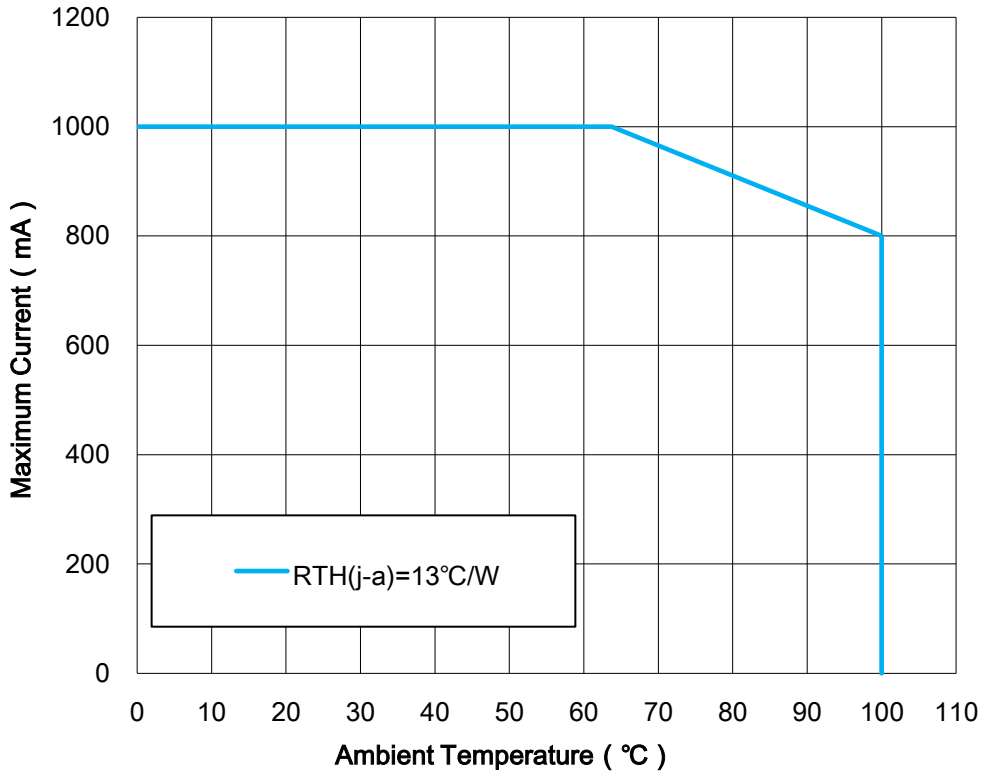
RELATIVE LUMINOUS FLUX VS. CURRENT ( $T_j=25^{\circ}\text{C}$ )



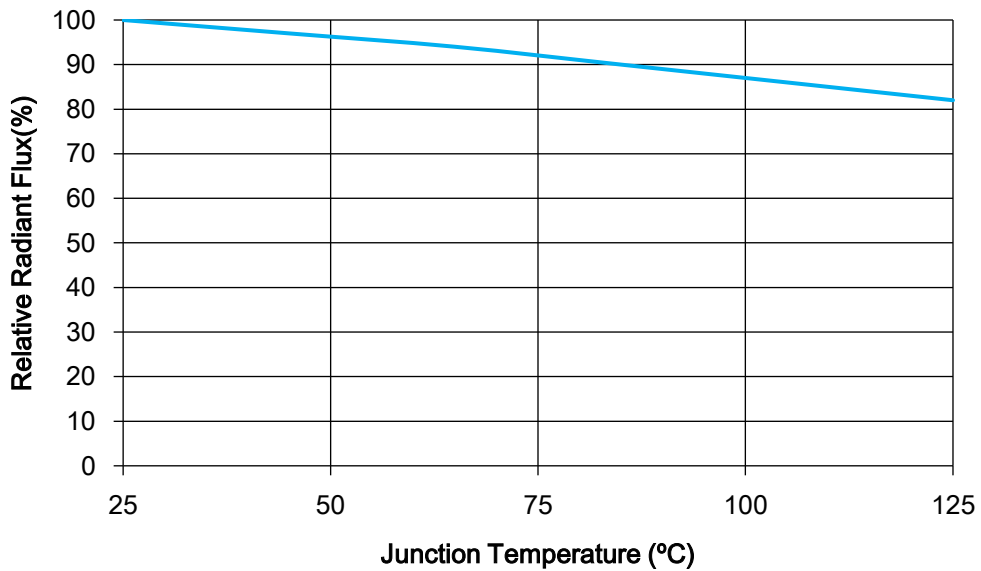
ELECTRICAL CHARACTERISTICS ( $T_j=25^{\circ}\text{C}$ )



MAXIMUM CURRENT VS. AMBIENT TEMPERATURE



RELATIVE RADIANT FLUX VS. JUNCTION TEMPERATURE



**SORTING RANKS**
**(1) Luminous Flux (Tj=25°C)**

Part Number	Condition	Rank	Unit
5050A06-27N75-2S5P-HV2-T-LX	750mA	X1	lm
		800-850	
5050A06-30N75-2S5P-HV2-T-LX		X3	
		840-890	
5050A06-35N75-2S5P-HV2-T-LX		X4	
		850-900	
5050A06-40N75-2S5P-HV2-T-LX		X6	
		880-930	
5050A06-50N75-2S5P-HV2-T-LX		X6	
		880-930	
5050A06-57N75-2S5P-HV2-T-LX		X6	
		880-930	
5050A06-60N75-2S5P-HV2-T-LX	X5		
	860-910		
5050A06-65N75-2S5P-HV2-T-LX	X5		
	860-910		

**(2) Forward Voltage (Tj=25°C)**

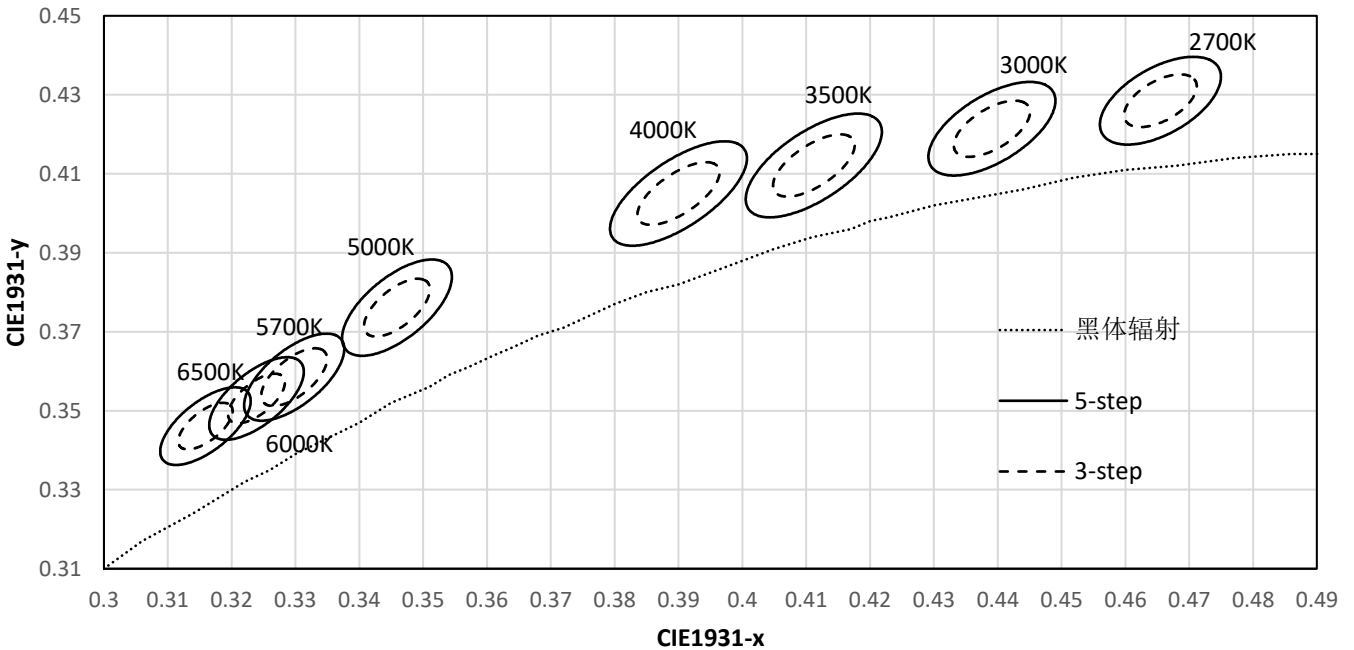
Rank	Condition	Min.	Max.	Unit
C9	750mA	5.8	6.0	V
D0		6.0	6.2	
D1		6.2	6.4	
D2		6.4	6.6	

Notes:

1. 10% tolerance for luminous intensity may be caused by measurement inaccuracy.
2. Measurement Uncertainty of the Forward Voltage :  $\pm 0.06V$

(3) Chromaticity Bins 色坐标等级

TC	Center Point		MAJOR AXIS (a ,b).		Theta <sub>o</sub>
	x	y	3-Step	5-Step	
2700K	0.4655	0.4285	(0.00774, 0.00411)	(0.0129, 0.00685)	53.17
3000K	0.4391	0.4214	(0.00834, 0.00408)	(0.0139, 0.0068)	53.22
3500K	0.4112	0.4121	(0.00927, 0.00414)	(0.01545, 0.0069)	54
4000K	0.3900	0.4050	(0.00939, 0.00402)	(0.01565, 0.0067)	53.72
5000K	0.3459	0.3761	(0.00822, 0.00354)	(0.0137, 0.0059)	59.62
5700K	0.3298	0.3585	(0.00747, 0.00318)	(0.01245, 0.00475)	59.13
6000K	0.3239	0.3531	(0.00708, 0.00300)	(0.01180, 0.0050)	59.21
6500K	0.3159	0.3461	(0.00669, 0.00285)	(0.01115, 0.00475)	58.57



Notes :

- 1.The above color coordinates measurement allowance tolerance is 0.005.
- 2.Some color and CRI bins may have limited availability, please contact us before ordering.

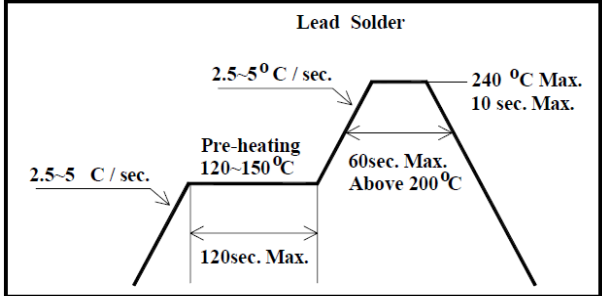
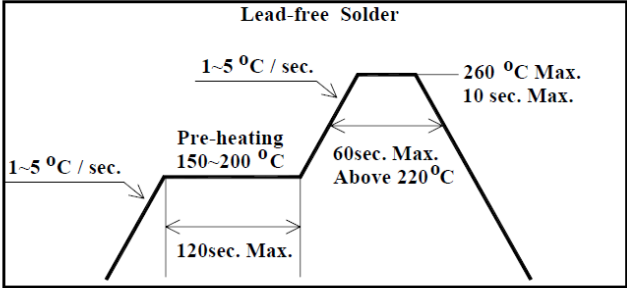
## REFLOW SOLDERING CHARACTERISTICS

### For Reflow Process:

Preheating : 140°C~160°C±5°C, within 2 minutes.  
 Operation heating : 260°C(Max.) within 10 seconds.(Max)  
 Gradual Cooling (Avoid quenching).

Lead solder		Lead-free solder	
Pre-heat	120-150°C	Pre-heat	150-200°C
Pre-heat time	120 sec.Max.	Pre-heat time	120 sec.Max.
Peak Temperature	240°C Max.	Peak Temperature	260°C Max.
Soldering time condition	10 sec.Max.	Soldering time condition	10 sec.Max.

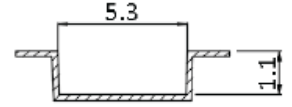
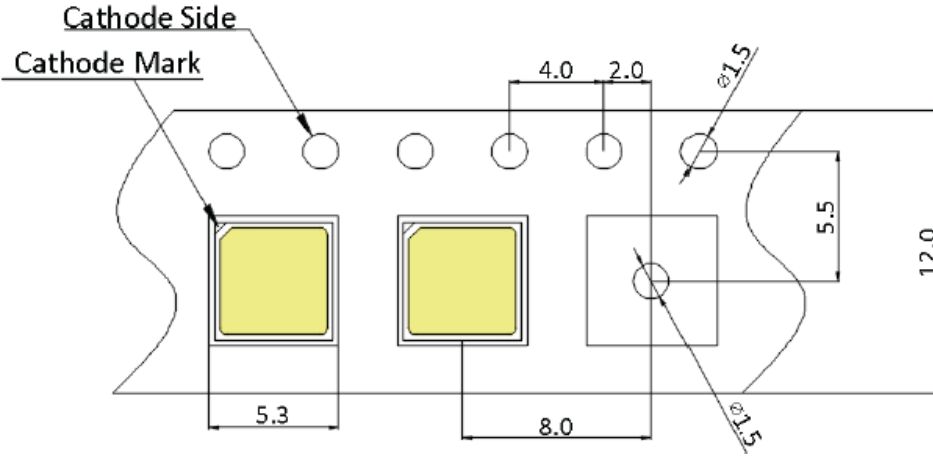
  

 <p><b>Lead Solder</b></p> <p>2.5-5 °C / sec. (up to 120°C)</p> <p>Pre-heating 120~150 °C (120sec. Max.)</p> <p>2.5-5 °C / sec. (up to 240°C)</p> <p>60sec. Max. Above 200 °C</p> <p>240 °C Max. (10 sec. Max.)</p>	 <p><b>Lead-free Solder</b></p> <p>1~5 °C / sec. (up to 150°C)</p> <p>Pre-heating 150~200 °C (120sec. Max.)</p> <p>1~5 °C / sec. (up to 260°C)</p> <p>60sec. Max. Above 220 °C</p> <p>260 °C Max. (10 sec. Max.)</p>
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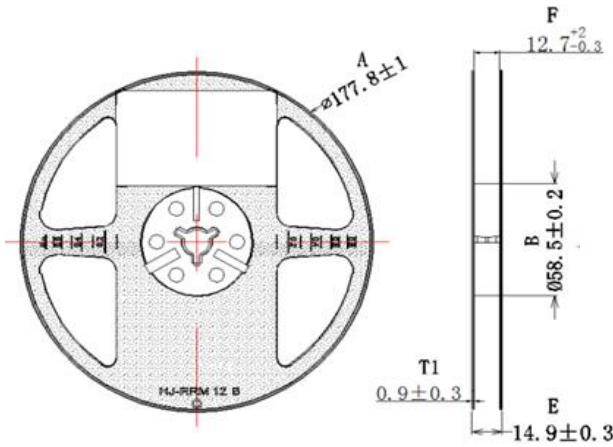
### Notes:

The encapsulated material of the LEDs is silicone . Therefore the LEDs have a soft surface on the top of package. The pressure to the top surface will be influence to the reliability of the LEDs. Precautions should be taken to avoid the strong pressure on the encapsulated part. So when using the picking up nozzle, the pressure on the silicone resin should be proper.

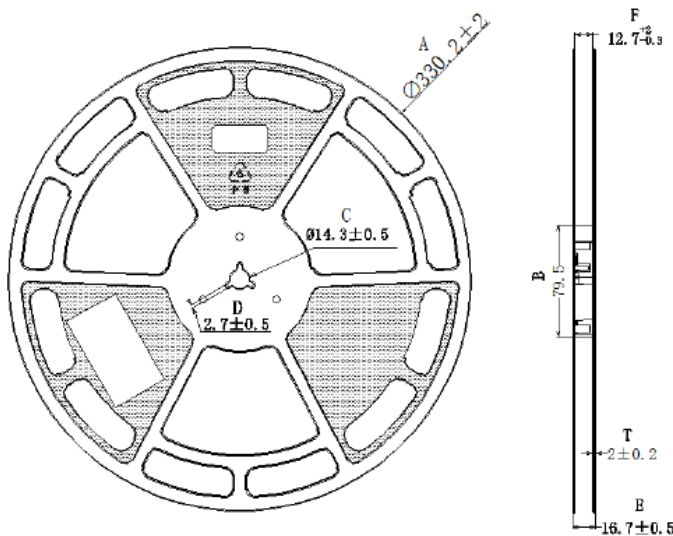
**TAPE AND REEL**



Small reel



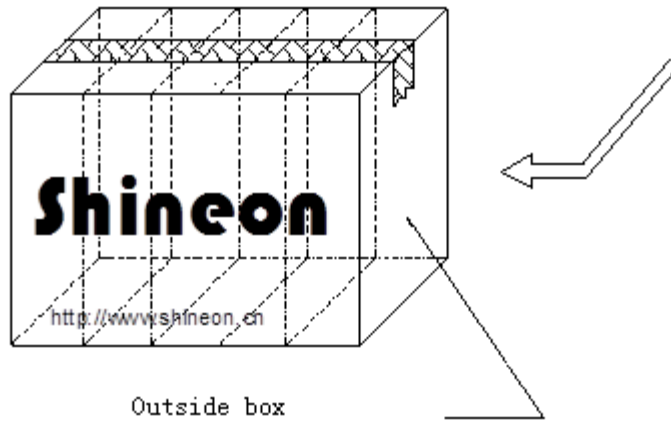
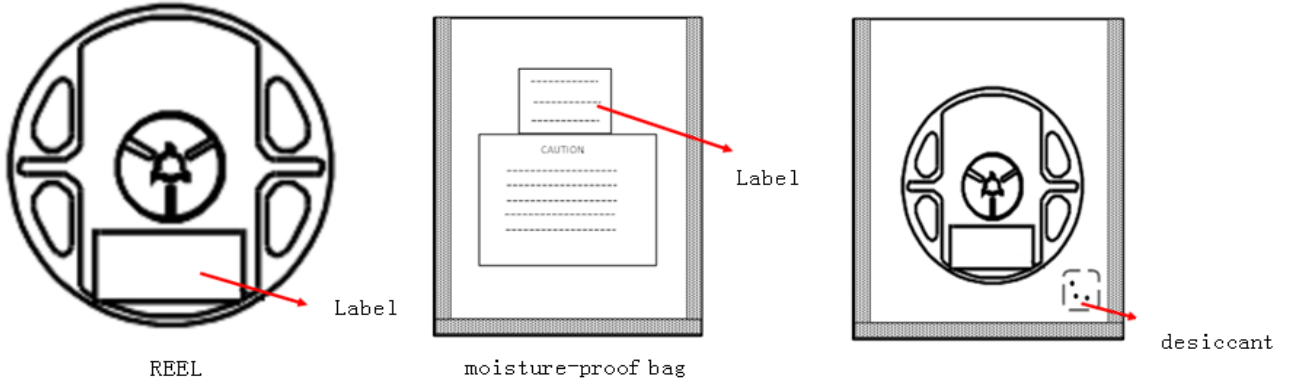
Big reel



Notes:

- (1) Quantity : 1500pcs/Reel OR 5,000pcs/Reel
- (2) Cumulative Tolerance : Cumulative Tolerance/10 pitches to be  $\pm 0.2\text{mm}$
- (3) Adhesion Strength of Cover Tape : Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at the angle of  $10^\circ$  to the carrier tape
- (4) Package : P/N, Manufacturing data Code No. and quantity to be indicated on a damp proof Package.

**PACKAGING**



Notes:

- (1) Box size: 33x25x42cm 60K/Box 1500pcs/Reel
- (2) Box size: 38x36x42cm 80K/Box 5000pcs/Reel,

**Reliability Test Items**

Test Items	Test Duration	Number of Damaged
Steady State Operating Life of High Temperature (HTOL) Ts=85°C, IF=Max	1000hrs	0/20
Steady State Operating Life of Low Temperature (LTOL) Ta=-40°C, IF=Max	1000hrs	0/20
High Temperature Storage (HTS) 100°C	1000hrs	0/20
Low Temperature Storage (LTS) -40°C	1000hrs	0/20
Thermal Shock (TS) -45°C~125°C 15min dwell 30sec transfer	100cycles	0/20
Solder Resistance (SR) 265°C, 3X MSL	5sec	0/20
Solder Ability (SA) 245°C5sec, 95% coverage	5sec	0/11
Mechanical Shock (MS) 1500G 0.5msec pulse shock	Each6 axis	0/6
Random Vibration (RV) 6G RMS, 10-2000Hz, 10min	Per axis	0/6
Variable Vibration Frequency (VVF) 10-2000-10Hz, log or linear sweep rate, 20G for 1 min, 1.5mm each apply 3x per axis over	6hrs	0/6
Salt Spread (SS) 35°C, 30g/m2/day	48hrs	0/11

Item	Symbol	Test Condition	Criteria for Judgment	
			Min.	Max.
Forward	Vf	IF=Typical Current		U.S.L x1.1
Luminous Flux	lm	IF=Typical Current	L.S.L x0.7	
CCX&CCY	x,y	IF=Typical Current		Shift<0.02

## PRECAUTION FOR USE

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- (1) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When washing is required, IPA should be used.
- (2) When the LEDs are illuminating, operating current should be decided after considering the ambient maximum temperature.
- (3) LEDs must be stored to maintain a clean atmosphere. If the LEDs are stored for 3 months or more after being shipped from ShineOn, a sealed container with a nitrogen atmosphere should be used for storage.
- (4) The LEDs must be used within seven days after opening the moisture proof packing. Repack unused Products with anti-moisture packing, fold to close any opening and then store in a dry place.
- (5) The appearance and specifications of the product may be modified for improvement without notice.
- (6) This LED is sensitive to the static electricity and surge. It is recommended to use a wrist Band or anti-electrostatic glove when handling the LEDs.
- (7) On manual soldering, a solder tip must be needed as grounded for usage. If over voltage which exceeds the absolute maximum rating is applied to LEDs, it will cause damage LEDs and result in destruction. Damaged LEDs will show some unusual characteristics such as leak current remarkably increase ,turn-on voltage becomes lower and the LEDs get unlighted at low current.